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HEF4517B

Dual 64-bit static shift register

Rev. 7 — 11 November 2011

Product data sheet

1. General description

The HEF4517B consists of two identical, independent 64-bit static shift registers. Each register has separate clock (nCP), data input (nD), parallel input-enable/output-enable (nPE/ \overline{OE}) and four 3-state outputs of the 16th, 32nd, 48th, and 64th bit positions (nQ16 to nQ64). Data at the nD input is entered into the first bit on the LOW-to-HIGH transition of the clock, regardless of the state of nPE/ \overline{OE} .

When nPE/OE is LOW, the outputs are enabled and it is in the 64-bit serial mode.

When nPE/OE is HIGH, the outputs are disabled (high-impedance OFF-state), the 64-bit shift register is divided into four 16-bit shift registers with nD, nQ16, nQ32 and nQ48 as data inputs of the 1st, 17th, 33rd, and 49th bit respectively. Schmitt-trigger action in the clock input makes the circuit highly tolerant of slower clock rise and fall times.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD} , V_{SS} , or another input.

2. Features and benefits

- Tolerant of slow clock rise and fall times
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

3. Ordering information

Table 1. Ordering information

All types operate from -40 °C to +85 °C

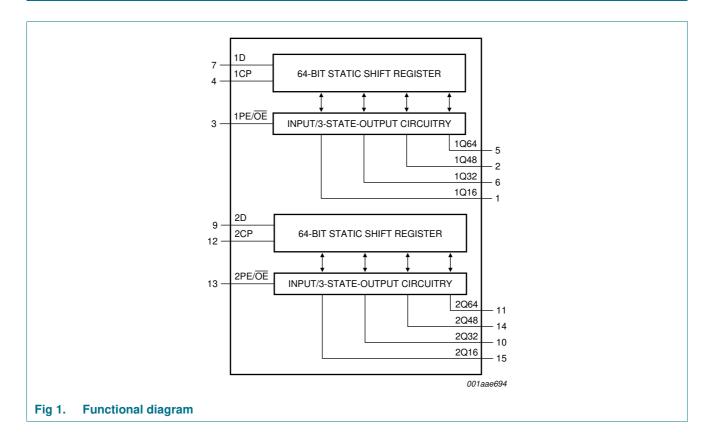
Type number	Package	Package								
	Name	Description	Version							
HEF4517BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4							
HEF4517BT	SO16	plastic small outline package; 16 leads; body width 7.5 mm	SOT162-1							

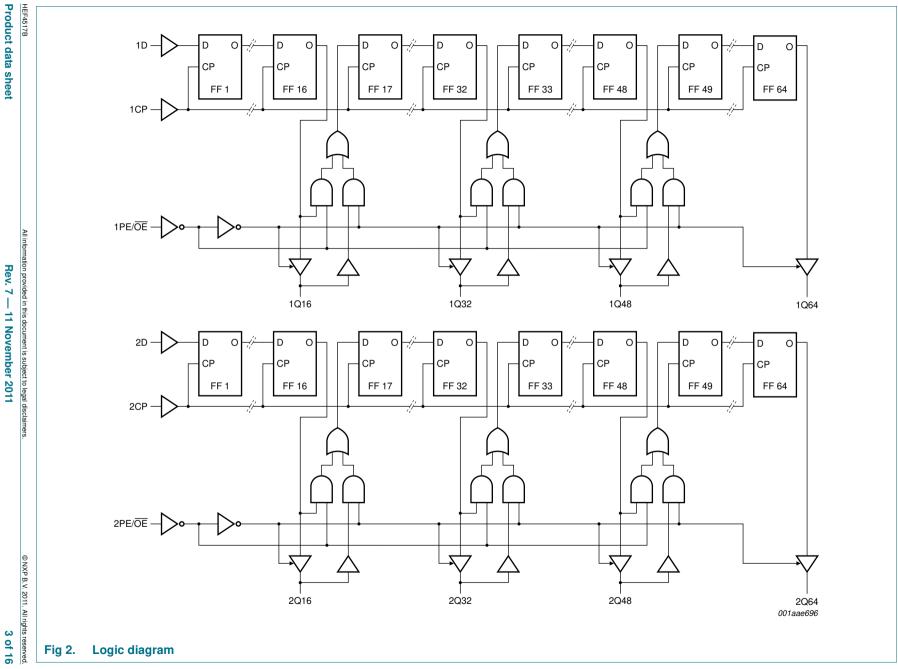


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4. Functional diagram

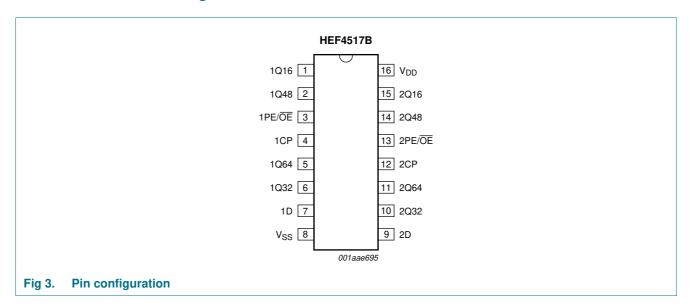




Dual 64-bit static shift register

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1Q16, 2Q16	1, 15	3-state input/output
1Q48, 2Q48	2, 14	3-state input/output
1PE/OE, 2PE/OE	3, 13	parallel input-enable/output-enable input
1CP, 2CP	4, 12	clock input
1Q64, 2Q64	5, 11	3-state input/output
1Q32, 2Q32	6, 10	3-state input/output
1D, 2D	7, 9	data input
V _{SS}	8	ground supply voltage
V_{DD}	16	supply voltage

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6. Functional description

Table 3. Function table[1]

Input	S		Inputs/output	S			Mode	
nCP	nD	nPE/OE	nQ16	nQ32	nQ48	nQ64		
↑	data entered into 1st bit	L	content of 16th bit displayed	content of 32nd bit displayed	content of 48th bit displayed	content of 64th bit displayed	One 64-bit shift register. The content of the shift register is shifted over one stage	
↑	data entered into 1st bit	Н	data at nQ16 entered into 17th bit	data at nQ32 entered into 33rd bit	data at nQ48 entered into 49th bit	remains in 'Z' state	Four 16-bit shift register. The content of the shift registers is shifted over one stage	
\downarrow	Χ	L	no change	no change	no change	no change	no change	
\downarrow	Χ	Н	Z	Z	Z	Z	no change	

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance state;

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_{l} < -0.5 \ V$ or $V_{l} > V_{DD} + 0.5 \ V$	-	±10	mA
V _I	input voltage		-0.5	$V_{DD} + 0.5$	V
l _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{DD} + 0.5 \text{ V}$	-	±10	mA
I _{I/O}	input/output current		-	±10	mA
I_{DD}	supply current		-	50	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+85	°C
P _{tot}	total power dissipation	DIP16 package	[1] -	750	mW
		SO16 package	[2] _	500	mW
Р	power dissipation	per output	-	100	mW

^[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

 $[\]uparrow$ = positive-going transition; \downarrow = negative-going transition.

^[2] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

Dual 64-bit static shift register

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DD}	supply voltage		3	-	15	V
V _I	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		V _{DD} = 10 V	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V

9. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0 \ V$; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	T _{amb} = -40 °C				T _{amb} = 85 °C		Unit
				Min	Max	Min	Max	Min	Max	
V_{IH}	HIGH-level input voltage	$ I_O < 1 \mu A$	5 V	3.5	-	3.5	-	3.5	-	٧
			10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
V_{IL}	LOW-level input voltage	$ I_O < 1 \mu A$	5 V	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V_{OH}	HIGH-level output voltage	$ I_O < 1 \mu A$	5 V	4.95	-	4.95	-	4.95	-	V
			10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V_{OL}	LOW-level output voltage	$ I_O < 1 \mu A$	5 V	-	0.05	-	0.05	-	0.05	V
			10 V	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	V
I _{OH}	HIGH-level output current	$V_0 = 2.5 \text{ V}$	5 V	-	-1.7	-	-1.4	-	-1.1	mA
		$V_{O} = 4.6 \text{ V}$	5 V	-	-0.52	-	-0.44	-	-0.36	mA
		V _O = 9.5 V	10 V	-	-1.3	-	-1.1	-	-0.9	mΑ
		V _O = 13.5 V	15 V	-	-3.6	-	-3.0	-	-2.4	mΑ
I _{OL}	LOW-level output current	$V_{O} = 0.4 \text{ V}$	5 V	0.52	-	0.44	-	0.36	-	mΑ
		V _O = 0.5 V	10 V	1.3	-	1.1	-	0.9	-	mA
		$V_{O} = 1.5 \text{ V}$	15 V	3.6	-	3.0	-	2.4	-	mA
l _l	input leakage current		15 V	-	±0.3	-	±0.3	-	±1.0	μΑ
I_{DD}	supply current	I _O = 0 A	5 V	-	50	-	50	-	375	μΑ
			10 V	-	100	-	100	-	750	μΑ
			15 V	-	200	-	200	-	1500	μΑ
Cı	input capacitance		-	-	-	-	7.5	-	-	рF

Dual 64-bit static shift register

10. Dynamic characteristics

Table 7. Dynamic characteristics

V_{SS} = 0 V; T_{amb} = 25 °C; for test circuit see Figure 8; unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	Extrapolation formula	Min	Тур	Max	Unit
t _{PHL}	HIGH to LOW	nCP to nQn;	5 V	193 ns + (0.55 ns/pF)C _L	-	220	440	ns
	propagation delay	see <u>Figure 4</u>	10 V	74 ns + (0.23 ns/pF)C _L	-	85	170	ns
			15 V	52 ns + $(0.16 \text{ ns/pF})C_L$	-	60	120	ns
t _{PLH}	LOW to HIGH	nCP to nQn;	5 V	163 ns + (0.55 ns/pF)C _L	-	190	380	ns
	propagation delay	see <u>Figure 4</u>	10 V	64 ns + $(0.23 \text{ ns/pF})C_L$	-	75	150	ns
			15 V	42 ns + $(0.16 \text{ ns/pF})C_L$	-	50	100	ns
t _{PHZ}	HIGH to OFF-state	nPE/OE to nQn;	5 V		-	40	80	ns
	propagation delay	see Figure 5	10 V		-	30	60	ns
			15 V		-	25	50	ns
t _{PZH}	OFF-state to HIGH	nPE/OE to nQn; see <u>Figure 5</u>	5 V		-	45	90	ns
	propagation delay		10 V		-	25	50	ns
			15 V		-	20	40	ns
t _{PLZ}	LOW to OFF-state	nPE/OE to nQn; see <u>Figure 5</u>	5 V		-	50	100	ns
	propagation delay		10 V		-	30	60	ns
			15 V		-	25	50	ns
t _{PZL}	OFF-state to LOW	nPE/OE to nQn; see <u>Figure 5</u>	5 V		-	60	120	ns
	propagation delay		10 V		-	30	60	ns
			15 V		-	25	50	ns
t _t	transition time	nQn; see <u>Figure 6</u>	5 V	10 ns + (1.00 ns/pF)C _L	-	60	120	ns
			10 V	9 ns + $(0.42 \text{ ns/pF})C_L$	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF)C _L	-	20	40	ns
t _{su}	set-up time	nQn, nD to nCP;	5 V		30	10	-	ns
		see Figure 7	10 V		25	5	-	ns
			15 V		20	5	-	ns
t _h	hold time	nQn, nD to nCP;	5 V		45	15	-	ns
		see Figure 7	10 V		30	10	-	ns
			15 V		25	10	-	ns
t _W	pulse width	nQn, nD to nCP;	5 V		-	95	190	ns
		see Figure 7	10 V		-	40	80	ns
			15 V		-	30	60	ns
f _{max}	maximum	see Figure 7	5 V		2	5	-	MHz
	frequency		10 V		6	12	-	MHz
			15 V		8	16	-	MHz

 $^{[1] \}quad \text{The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).}$

Table 8. Dynamic power dissipation P_D

 P_D can be calculated from the formulas shown. $V_{SS} = 0 \ V$; $t_r = t_f \le 20 \ ns$; $T_{amb} = 25 \ ^{\circ}C$.

Symbol	Parameter	V_{DD}	Typical formula for P _D (μW)	where:
P_D	dynamic power	5 V	$P_D = 7000 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f_i = input frequency in MHz,
	dissipation	10 V	$P_D = 28000 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f _o = output frequency in MHz,
		15 V	$P_D = 70000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$	C_L = output load capacitance in pF,
				V_{DD} = supply voltage in V,
				$\Sigma(f_0\times C_L)$ = sum of the outputs.

11. Waveforms

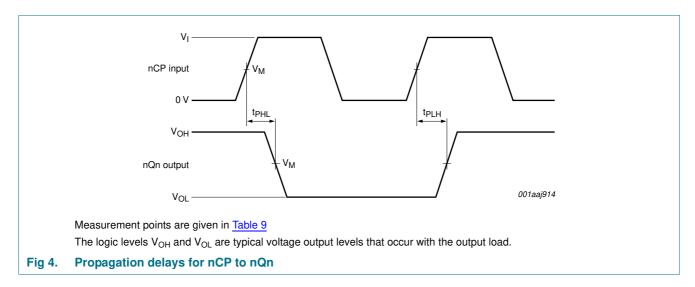
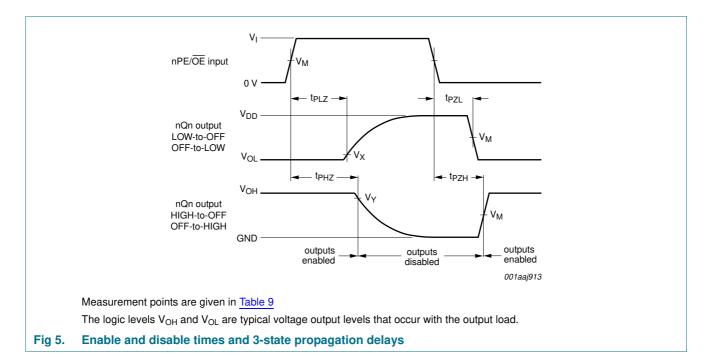
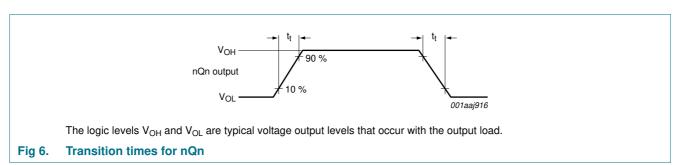
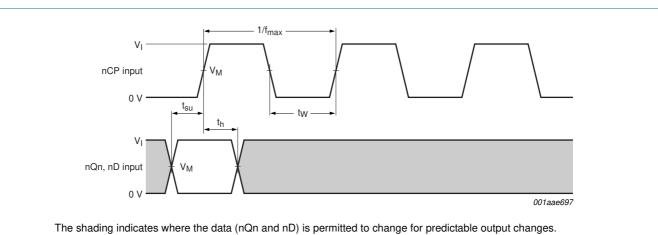


Table 9. Measurement points

Input	Output		
V_{M}	V_{M}	V _X	V _Y
0.5V _I	$0.5V_{DD}$	$0.1V_{DD}$	0.9V _{DD}





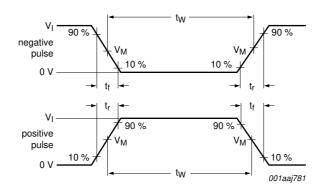


The shading indicates where the data (nQn and nD) is permitted to change for predictable output changes. Measurement points are given in Table 9

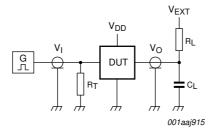
The logic levels V_{OH} and V_{OL} are typical voltage output levels that occur with the output load.

Fig 7. Waveforms showing minimum clock pulse width and maximum frequency and set-up and hold times for nQn (as data input) or nD to nCP

Dual 64-bit static shift register



a. Input waveforms



b. Test circuit

Test data is given in Table 10.

Definitions for test circuit:

DUT = Device Under Test;

R_L = Load resistance;

C_L = Load capacitance including jig and probe capacitance;

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

Fig 8. Test circuit for switching times

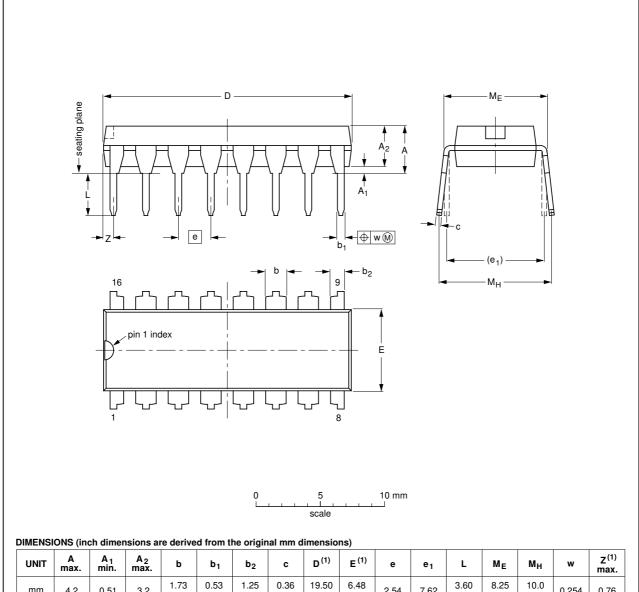
Table 10. Test data

Supply voltage	Input		Load		V _{EXT}			
	VI	t _r , t _f	C _L	R _L	t _{PLH} , t _{PHL}	t _{PLZ,} t _{PZL}	t _{PHZ} , t _{PZH}	
5 V to 15 V	V_{DD}	≤ 20 ns	50 pF	1 kΩ	open	$2V_{DD}$	GND	

12. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA	PROJECTION	1330E DATE	
SOT38-4					95-01-14 03-02-13	

Fig 9. Package outline SOT38-4 (DIP16)

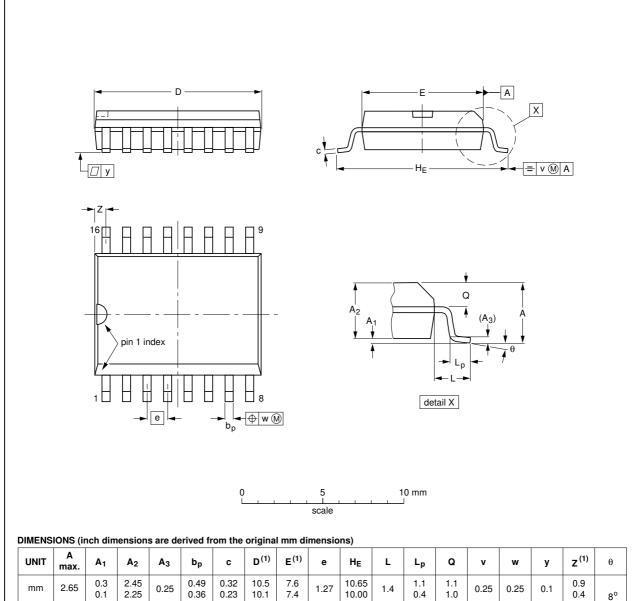
HEF4517B

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SO16: plastic small outline package; 16 leads; body width 7.5 mm

SOT162-1



UNIT	A max.	A ₁	A ₂	A 3	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	2.65	0.3 0.1	2.45 2.25	0.25	0.49 0.36	0.32 0.23	10.5 10.1	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.1	0.012 0.004	0.096 0.089	0.01	0.019 0.014		0.41 0.40	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016		0.01	0.01	0.004	0.035 0.016	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	IOOUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT162-1	075E03	MS-013				99-12-27 03-02-19	

Fig 10. Package outline SOT162-1 (SO16)

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NXP Semiconductors

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HEF4517B

13. Revision history

Table 11. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4517B v.7	20111111	Product data sheet	-	HEF4517B v.6
Modifications:	 Section App 	olications removed		
	 <u>Table 6</u>: I_{OF} 	_I minimum values changed t	o maximum	
	• <u>Figure 8</u> : ad	dded "DUT = Device Under ⁻	Test"	
HEF4517B v.6	20091210	Product data sheet	-	HEF4517B v.5
HEF4517B v.5	20090728	Product data sheet	-	HEF4517B v.4
HEF4517B v.4	20090406	Product data sheet	-	HEF4517B_CNV v.3
HEF4517B_CNV v.3	19950101	Product specification	-	HEF4517B_CNV v.2
HEF4517B_CNV v.2	19950101	Product specification	-	-

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
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NXP Semiconductors

HEF4517B

Dual 64-bit static shift register

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